

### STY139N65M5

## N-channel 650 V, 0.014 Ωtyp., 130 A, MDmesh™ V Power MOSFET in Max247 package

Datasheet — production data

### **Features**

Order code	V <sub>DS</sub> @T <sub>jMAX</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STY139N65M5	710 V	0.017 Ω	130 A

- Max247 worldwide best R<sub>DS(on)</sub>
- Higher V<sub>DSS</sub> rating
- Higher dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested



Switching applications



The device is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

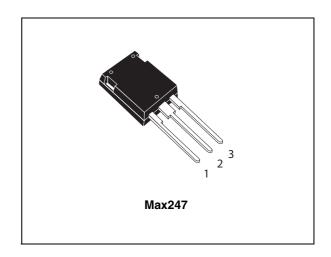


Figure 1. Internal schematic diagram

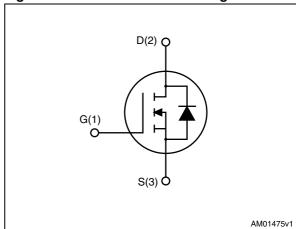


Table 1. Device summary

Order code	Marking	Package	Packaging
STY139N65M5	139N65M5	Max247	Tube

Contents STY139N65M5

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STY139N65M5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate- source voltage	± 25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	130	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	78	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	520	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	625	W
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by $T_{JMAX}$ )	17	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	2400	mJ
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	°C

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.2	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	30	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300	°C

<sup>2.</sup>  $I_{SD} \leq 130 \text{ A}, \text{ di/dt} = 400 \text{ A/}\mu\text{s}, V_{DD} = 400 \text{ V}, \text{ peak } V_{DS} < V_{(BR)DSS}.$ 

Electrical characteristics STY139N65M5

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	650			V
I <sub>DSS</sub>		V <sub>DS</sub> = 650 V V <sub>DS</sub> = 650 V, T <sub>C</sub> =125 °C			10 100	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 65 \text{ A}$		0.014	0.017	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	15600 365 9	-	pF pF pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	1559	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	360	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.2	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 65 \text{ A},$		363		nC
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V	-	88	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 15)		164		nC

<sup>1.</sup>  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

<sup>2.</sup>  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(v)</sub>	Voltage delay time	$V_{DD} = 400 \text{ V}, I_{D} = 80 \text{ A},$		295		ns
t <sub>r(v)</sub>	Voltage rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$		56		ns
t <sub>f(i)</sub>	Current fall time	(see Figure 16)	-	37	_	ns
t <sub>c(off)</sub>	Crossing time	(see Figure 19)		84		ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		130 520	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 130 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>SD</sub> = 130 A, di/dt = 100 A/µs V <sub>DD</sub> = 100 V (see <i>Figure 16</i> )	_	570 15 53		ns μC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 130 A, di/dt = 100 A/µs $V_{DD}$ = 100 V, $T_{j}$ = 150 °C (see <i>Figure 16</i> )	-	720 24 68		ns μC Α

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

**Electrical characteristics** STY139N65M5

#### **Electrical characteristics (curves)** 2.1

Figure 2. Safe operating area

Figure 3. Thermal impedance

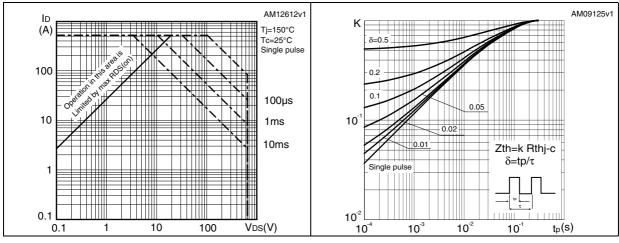


Figure 4. **Output characteristics** 

Figure 5. **Transfer characteristics** 

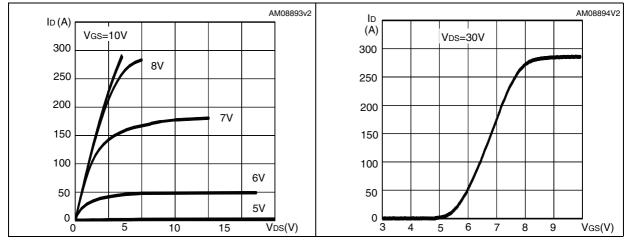


Figure 6. Normalized B<sub>VDSS</sub> vs temperature Figure 7.

Static drain-source on resistance AM12613V1  $RDS(on) \ (\Omega)$ Vgs=10V 0.016 0.015 0.014 0.013 0.012 0.011 <sup>l</sup> 40 60 80 100 ID(A)

AM10399v1 VDS (norm) 1.08 ID = 1mA1.06 1.04 1.02 1.00 0.98 0.96 0.94 0.92 -50

25 50 75 100 TJ(°C)

0

-25

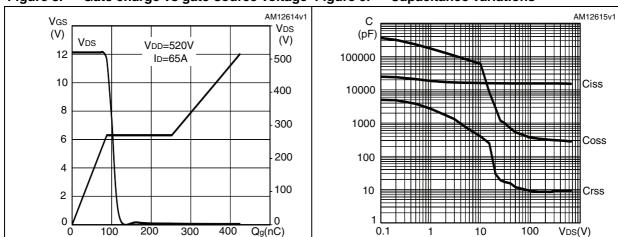


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

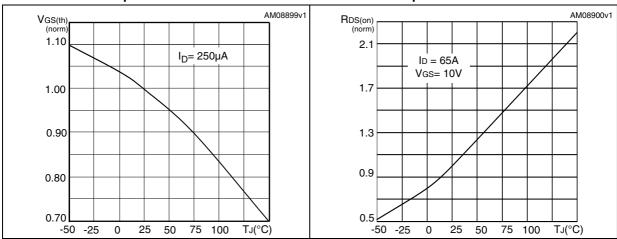
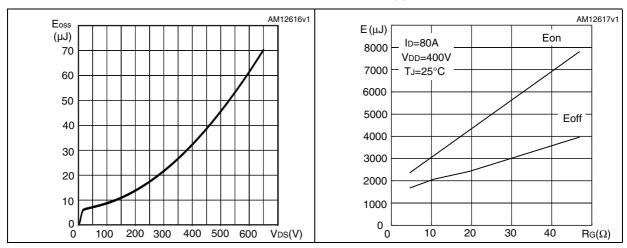


Figure 12. Output capacitance stored energy Figure 13. Switching losses vs gate resistance



<sup>1.</sup> Eon including reverse recovery of a SiC diode.

Test circuits STY139N65M5

### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

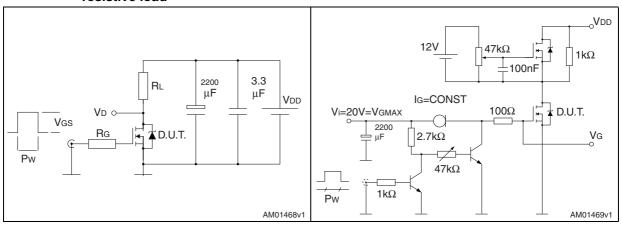


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

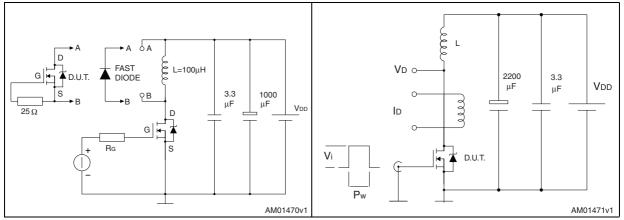
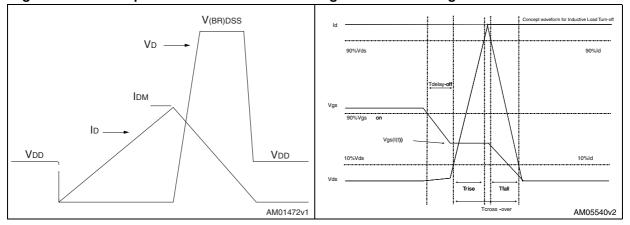


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



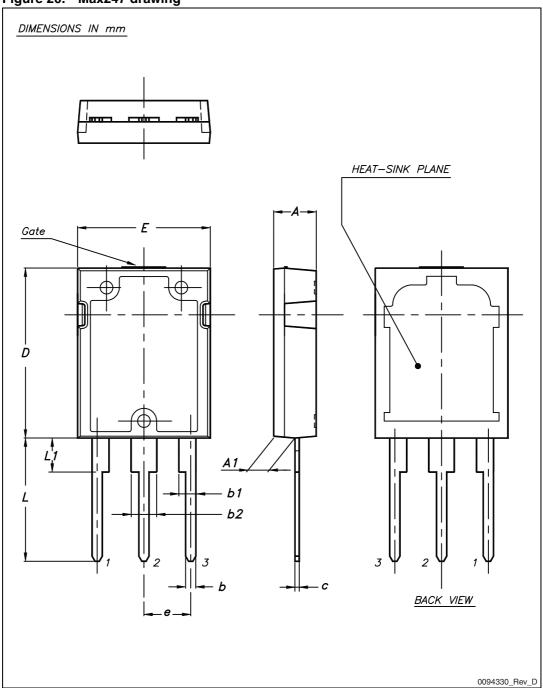
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. Max247 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	4.70		5.30
A1	2.20		2.60
b	1.00		1.40
b1	2.00		2.40
b2	3.00		3.40
С	0.40		0.80
D	19.70		20.30
е	5.35		5.55
E	15.30		15.90
L	14.20		15.20
L1	3.70		4.30

Figure 20. Max247 drawing



Revision history STY139N65M5

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
09-Mar-2012	1	First release.
04-Apr-2012	2	Inserted new Section 2.1: Electrical characteristics (curves). Updated Section 4: Package mechanical data.
19-Apr-2012	3	Document promoted from preliminary data to production data. Updated Section 4: Package mechanical data.
24-Jan-2013	4	<ul><li>Minor text changes</li><li>Modified: I<sub>AR</sub> E<sub>AS</sub> values on <i>Table 2</i></li></ul>

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